

Optocoupler with Phototransistor Output

Description

The K814P/K824P/K844P consist of a phototransistor optically coupled to 2 gallium arsenide infrared-emitting diodes (reversed polarity) in an 4-lead up to 16-lead plastic dual inline package. The elements are mounted on one leadframe using a **coplanar technique**, providing a fixed distance between input and output for highest safety requirements.

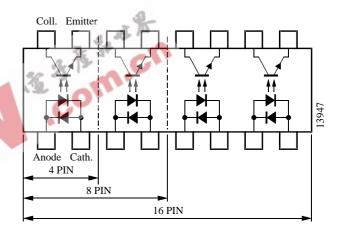


Feature phones, answering machines, PABX, fax machines

14925

Features

- Endstackable to 2.54 mm (0.1') spacing
- DC isolation test voltage V_{IO} = 5 kV
- Low coupling capacitance of typical 0.3 pF
- Current Transfer Ratio (CTR) of typical 100%
- Low temperature coefficient of CTR
- Wide ambient temperature range
- Underwriters Laboratory (UL) 1577 recognized, file number E-76222
- ◆ CSA (C-UL) 1577 recognized, file number E-76222 – Double Protection
- Coupling System U





Order Instruction

Ordering Code	CTR Ranking	Remarks
K814P	< 20%	4 Pin Single channel
K824P	< 20%	8 Pin Dual channel
K844P	< 20%	16 Pin Quad channel

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Absolute Maximum Ratings

Input (Emitter)

Parameter	Test Conditions	Symbol	Value	Unit
Reverse voltage		V_{R}	6	V
Forward current		I _F	±60	mA
Forward surge current	t _p ≤ 10 μs	I _{FSM}	±1.5	Α
Power dissipation	T _{amb} ≤ 25°C	P_V	100	mW
Junction temperature		T _i	125	°C

Output (Detector)

Parameter	Test Conditions	Symbol	Value	Unit
Collector emitter voltage		V_{CEO}	70	V
Emitter collector voltage		V _{ECO}	7	V
Collector current		I _C	50	mA
Peak collector current	$t_p/T = 0.5, t_p \le 10 \text{ ms}$	I _{CM}	100	mA
Power dissipation	T _{amb} ≤ 25°C	P_{V}	150	mW
Junction temperature		T _i	125	°C

Coupler

Junction temperature			125	ن					
Coupler									
Parameter	Test Conditions	Symbol	Value	Unit					
AC Isolation test voltage (RMS)	t = 1 min	V _{IO} 1)	5	kV					
Total power dissipation	T _{amb} ≤ 25°C	P _{tot}	250	mW					
Operating ambient temperature range		T _{amb}	-40 to +100	°C					
Storage temperature range		T _{stg}	-55 to +125	°C					
Soldering temperature	2 mm from case, t ≤ 10 s	T _{sd}	260	°C					
1) Related to standard climate 23/50 DIN 50014									

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Electrical Characteristics (T_{amb} = 25°C)

Input (Emitter)

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Forward voltage	$I_F = \pm 50 \text{ mA}$	V_{F}		1.25	1.6	V
Reverse current	$V_R = \pm 6 V$	I _R			10	μΑ

Output (Detector)

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Collector emitter voltage	I _C = 100 μA	V_{CEO}	70			V
Emitter collector voltage	I _E = 100 μA	V _{ECO}	7			V
Collector dark current	$V_{CF} = 20 \text{ V}, I_F = 0, E = 0$	I _{CEO}			100	nA

Coupler

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Collector emitter	$I_F = \pm 10 \text{ mA}, I_C = 1 \text{ mA}$	V _{CEsat}			0.3	V
saturation voltage						
Cut-off frequency	$I_F = \pm 10 \text{ mA}, V_{CE} = 5 \text{ V},$	f _c	- 4	100		kHz
	$R_L = 100 \Omega$		4, 15.1			
Coupling capacitance	f = 1 MHz	C _k	34	0.3		pF

Current Transfer Ratio (CTR)

Parameter	Test Conditions	Туре	Symbol	Min.	Тур.	Max.	Unit
Ic/IE	$V_{CE} = 5 \text{ V. } I_{E} = \pm 5 \text{ mA}$, ,	CTR	0.2		3.0	

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Switching Characteristics

Parameter	Test Conditions	Symbol	Тур.	Unit
Delay time	$V_S = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega \text{ (see figure 1)}$	t _d	3.0	μs
Rise time		t _r	3.0	μs
Fall time		t _f	4.7	μs
Storage time		ts	0.3	μs
Turn-on time		t _{on}	6.0	μS
Turn-off time		t _{off}	5.0	μS
Turn-on time	$V_S = 5 \text{ V}, I_F = 10 \text{ mA}, R_L = 1 \text{ k}\Omega \text{ (see figure 2)}$	t _{on}	9.0	μS
Turn-off time		t _{off}	18.0	μS

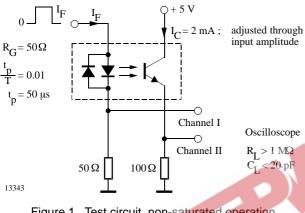


Figure 1. Test circuit, non-saturated operation

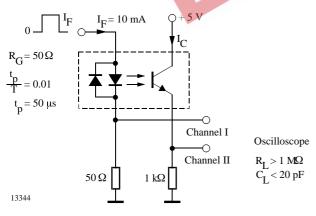


Figure 2. Test circuit, saturated operation

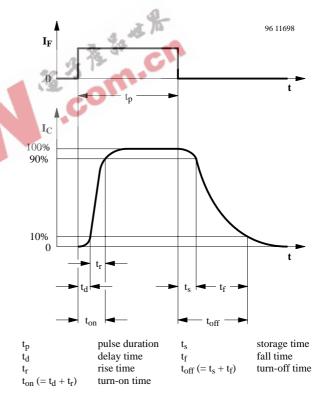


Figure 3. Switching times

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Typical Characteristics (T_{amb} = 25°C, unless otherwise specified)

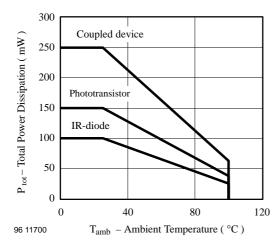


Figure 4. Total Power Dissipation vs. Ambient Temperature

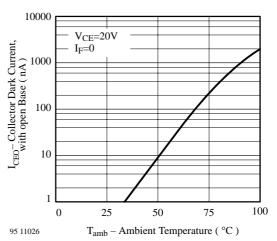


Figure 7. Collector Dark Current vs. Ambient Temperature

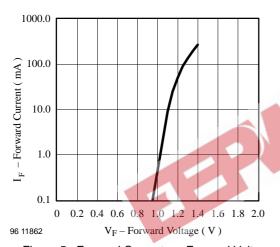


Figure 5. Forward Current vs. Forward Voltage

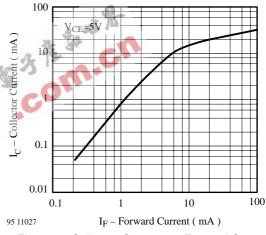


Figure 8. Collector Current vs. Forward Current

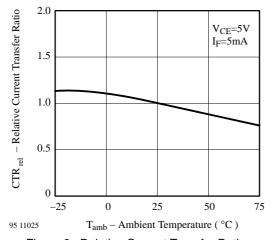


Figure 6. Relative Current Transfer Ratio vs.

Ambient Temperature

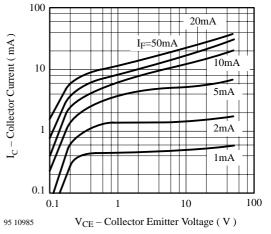


Figure 9. Collector Current vs. Collector Emitter Voltage

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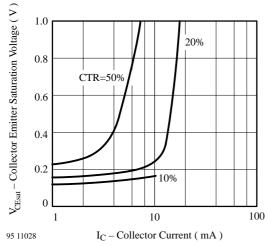


Figure 10. Collector Emitter Saturation Voltage vs. Collector Current

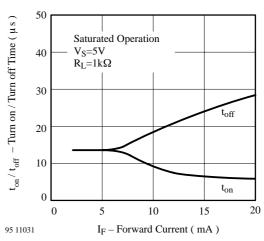


Figure 12. Turn on / off Time vs. Forward Current

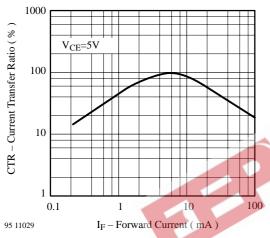


Figure 11. Current Transfer Ratio vs. Forward Current

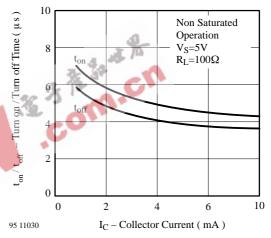
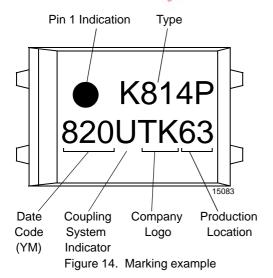


Figure 13. Turn on / off Time vs. Collector Current

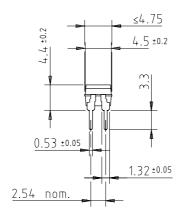


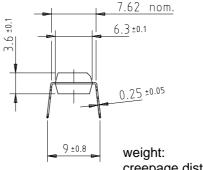
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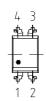
Dimensions of K814P in mm

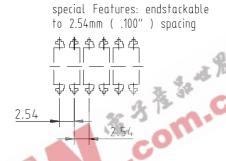




ca. 0.25 g creepage distance: ≥ 6 mm air path: \geq 6 mm

after mounting on PC board



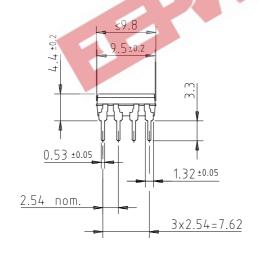


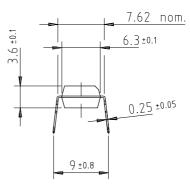
E.g.:



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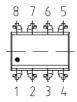
Dimensions of K824P in mm





weight: ca. 0.55 g creepage distance: ≥ 6 mm air path: \geq 6 mm

after mounting on PC board





technical drawings according to DIN specifications

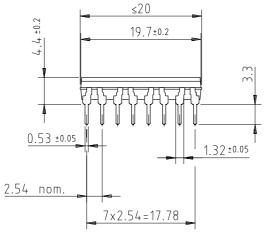
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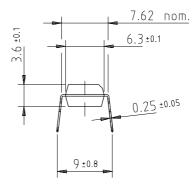
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Dimensions of K844P in mm





weight: air path: 16 15 14 13 12 11 10 9 . mounting

creepage distance: ≥ 6 mm \geq 6 mm

after mounting on PC board

technical drawings according to DIN specifications

ca. 1.0 g

14783

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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany Telephone: 49 (0) 7131 67 2831, Fax number: 49 (0) 7131 67 2423

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Datasheets for electronics components.

